Andrney Docket No. 5308-299

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

: Andrews et al.

U.S. Patent No.: 7,008,861

Application Serial No.: 10/733,845

Issued: March 7, 2006

Filed: December 11, 2003

Semiconductor Substrate Assemblies and Methods for Preparing and Dicing the Same

Date: May 4, 2006

Commissioner for Patents

Attn: Certificate of Correction Branch

P.O. Box 1450

Alexandria, VA 22313-1450

REQUEST FOR ENTRY OF CERTIFICATE OF CORRECTION UNDER 35 U.S.C §254 AND 37 C.F.R. §1.322

Sir:

The Assignee of record for the above-referenced patent hereby requests, pursuant to 35 U.S.C §254 and 37 C.F.R. §1.322, that a Certificate of Correction be issued. This request is made in order to correct the mistakes incurred through the fault of the U.S. Patent and Trademark Office. No fee is believed due. However, the Commissioner is authorized to charge any deficiency or credit any overpayment to Deposit Account No. 50-0220.

The mistakes appearing in the patent are set forth with corrections on the Certificate of Correction enclosed herewith, with an additional copy thereof and a return post card.

Respectfully submitted,

David D. Beatty

Registration No. 38,071

Myers Bigel Sibley & Sajovec, P.A.

P. O. Box 37428

Raleigh, North Carolina 27627

Telephone: (919) 854-1400 Facsimile: (919) 854-1401

Customer No. 20792

Partificate

MAY 1 2 2006

of Correction

Certificate of Mailing under 37 CFR 1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, Attn: Certificate of Correction Branch, P.O. Box 1450, Alexandria, VA 22313-1450 on May 4, 2006.

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Unrection

UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO.

7,008,861

DATED

March 7, 2006

INVENTOR(S)

Andrews et al.

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 13,

Line 50 should read -- has a depth in the substrate of at least about 25 μm. --

Column 15,

Line 13 should read -- d) an isolation trench in the at least one device layer, the --

Line 37 should read -- 49. The assembly of claim 35 wherein the shaping trench --

Line 40 should read -- 50. The assembly of claim 35 wherein the shaping trench --

Line 45 should read -- 52. The assembly of claim 35 wherein the shaping trench --

MAILING ADDRESS OF SENDER: Myers, Bigel, Sibley & Sajovec P.O. Box 37428 Raleigh, NC 27627 PATENT NO. 7,008,861 No. of additional copies: ____

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This collection of information is required by 37 CFR 1.322, 1.323, and 1.324. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 1.0 hour to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you are required to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Attention Certificate of Corrections Branch, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

